

MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

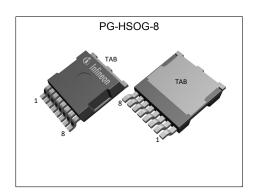
- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

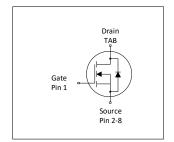
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	150	V
R _{DS(on),max}	5.4	mΩ
I _D	143	A
Qoss	163	nC
Q _G	58	nC











Type / Ordering Code	Package	Marking	Related Links
IPTG054N15NM5	PG-HSOG-8	054N15N5	-

OptiMOSTM 5 Power-Transistor, 150 V IPTG054N15NM5



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OptiMOS[™] 5 Power-Transistor, 150 V PTG054N15NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Ol		Value	s		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	143 101 96 17.5	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =8 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25°C, R_{thJA} =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	572	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	211	mJ	I_D =100 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	250 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.6	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)		-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 150 V IPTG054N15NM5



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Value	s		
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	V _{DS} =V _{GS} , I _D =191 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	4.4 4.9	5.4 6.0	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =8 V, I _D =25 A
Gate resistance ¹⁾	R _G	-	0.9	1.2	Ω	-
Transconductance	g fs	-	95	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 \text{ A}$

Table 5 **Dynamic characteristics**

Paramatan	Ol	Values			11	Nata / Tank Oam distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	4400	5700	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1100	1600	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	25	44	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	16	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	5.0	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	21	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	5.0	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cymbal	Values			11:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	24	-	nC	V_{DD} =75 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	16.6	-	nC	V_{DD} =75 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	12	18	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	19	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	58	73	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.5	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Qoss	-	163	217	nC	V _{DS} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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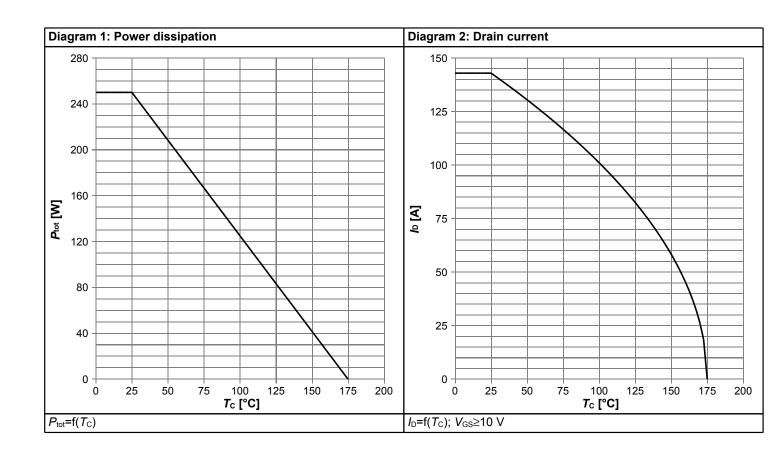


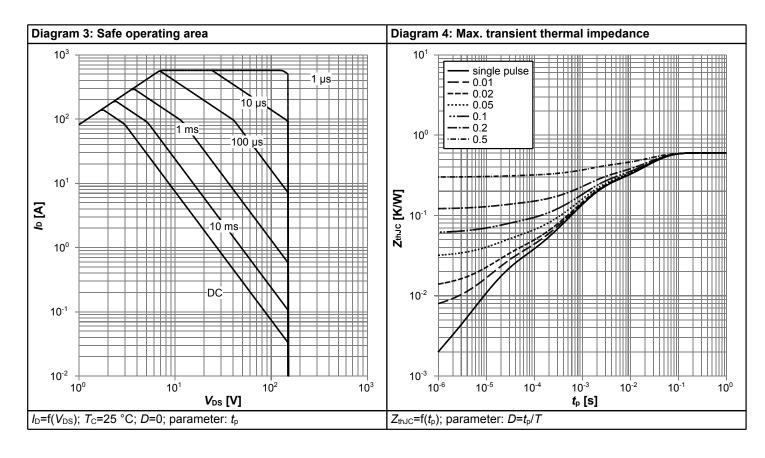
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata / Tank Canadidan
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	143	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	572	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.83	1.0	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	48	96	ns	V _R =75 V, I _F =50 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	61	121	nC	V _R =75 V, I _F =50 A, di _F /dt=100 A/μs

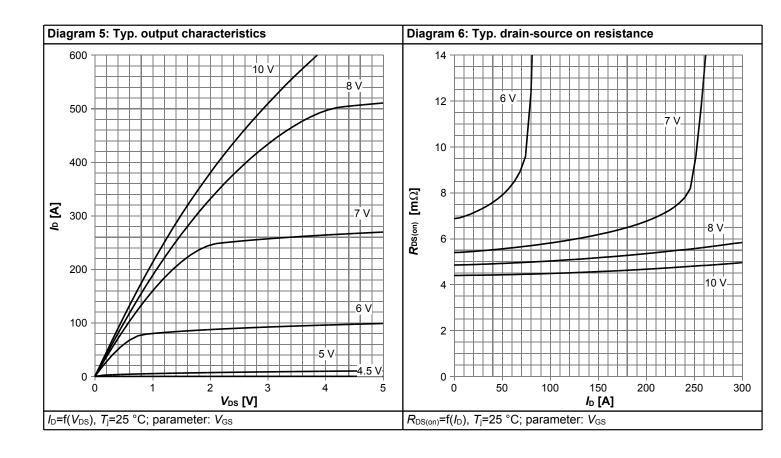


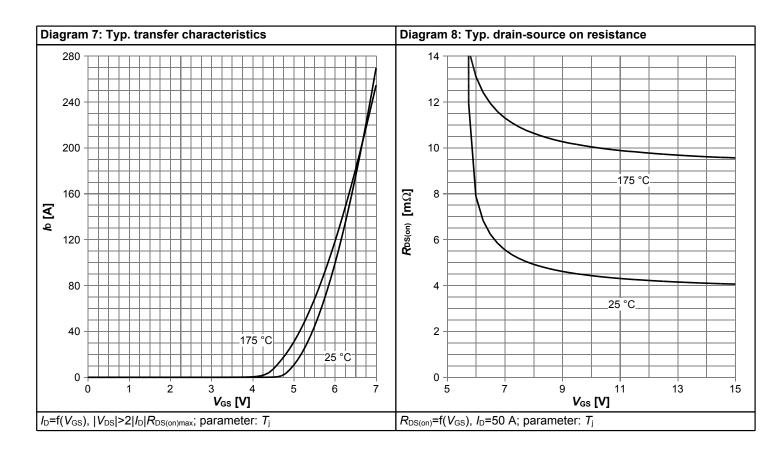
4 Electrical characteristics diagrams



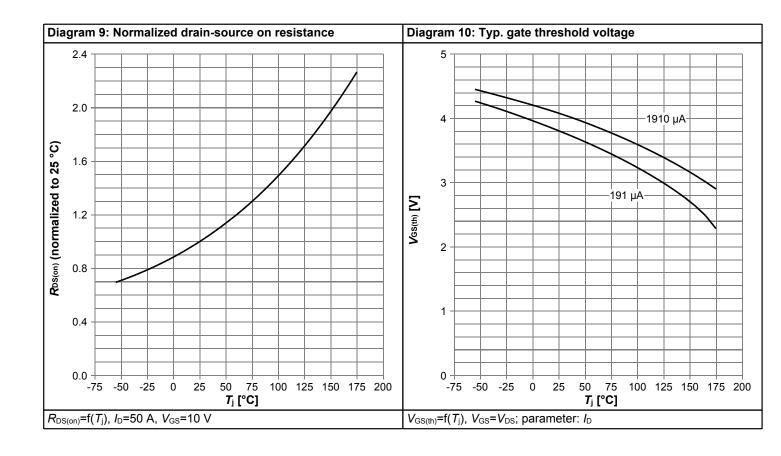


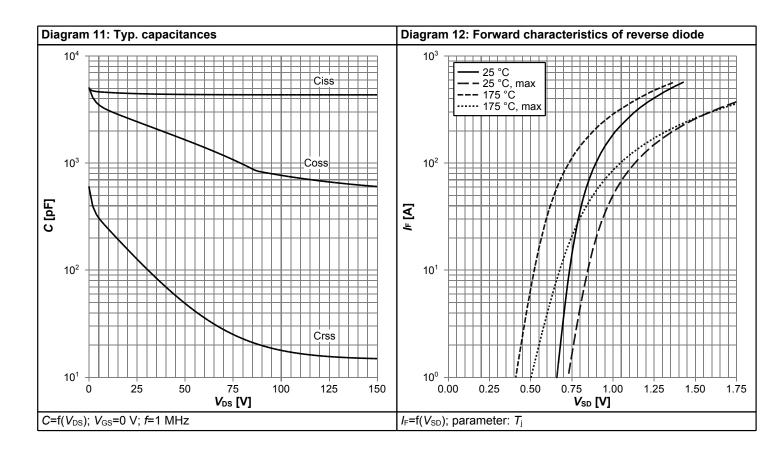




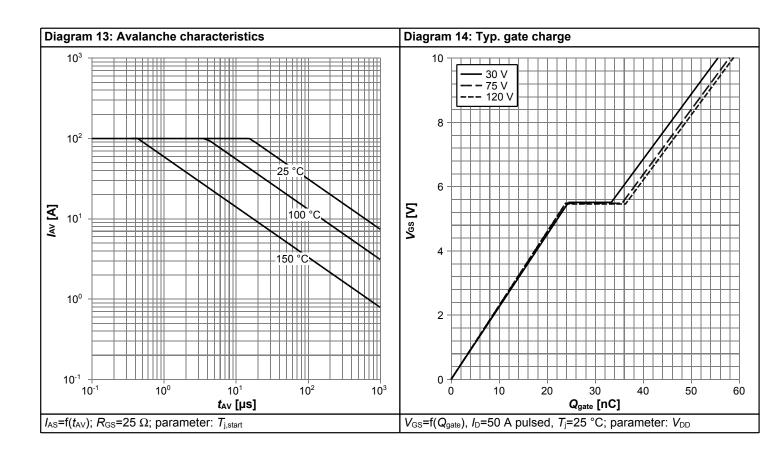


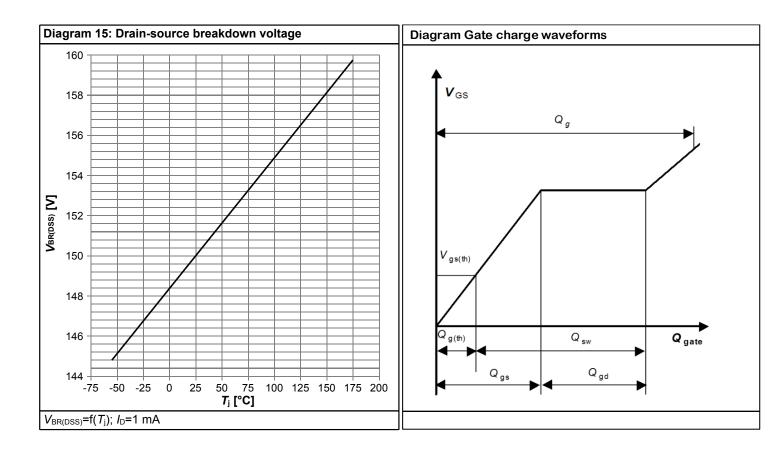






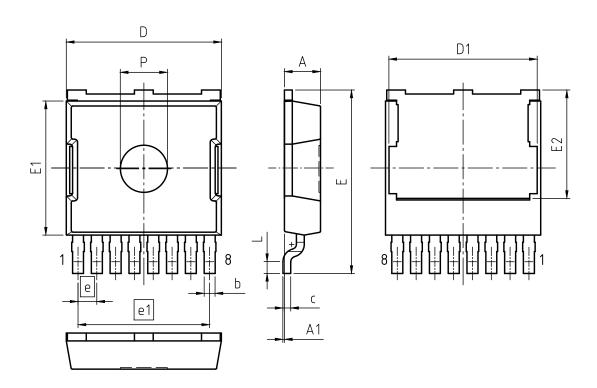








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HSC	PG-HSOG-8-U01				
REVISION: 01	DATE	: 08.02.2021				
DIMENSIONS	MILLIN	IETERS				
DIVIENSIONS	MIN.	MAX.				
Α	2.20	2.40				
A1	0.00	0.10				
b	0.60	0.80				
С	0.40	0.60				
D	9.70	10.10				
D1	9.36	9.56				
E	11.50	11.90				
E1	8.45	8.75				
E2	6.81	7.01				
е	1.	20				
e1	8.	.40				
L	0.66	0.86				
P	2.90	3.10				

Figure 1 Outline PG-HSOG-8, dimensions in mm



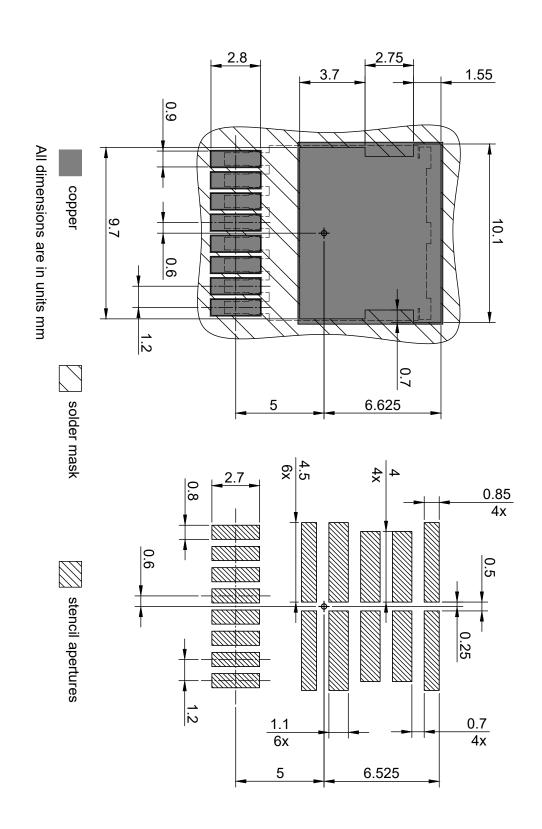


Figure 2 Outline Footprint (PG-HSOG-8), dimensions in mm



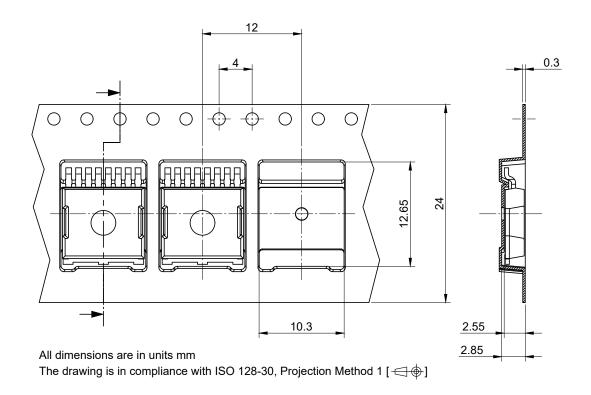


Figure 3 Outline Tape (PG-HSOG-8), dimensions in mm

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Revision History

IPTG054N15NM5

Revision: 2023-03-08, Rev. 2.1

Previous Revision

	Torrodo Novicion							
Revision	Date Subjects (major changes since last revision)							
2.0	2022-05-05	Release of final version						
2.1	2023-03-08	Update Coss max						

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